

800G Twin-port OSFP 2x400Gb/s Multimode 2xSR4 50m Transceiver

Features

- 800G 2xSR4 multimode transceiver
- 8-channels of 100G-PAM4 electrical modulation
- Two ports of 4-channel 100G-PAM4 optical modulation
- Supports two straight 400Gb/s or two 1:2 splitter fiber cables for 200Gb/s
- Finned-top OSFP for air-cooled switches
- 850nm VCSEL
- Maximum reach: 30m using OM3 fiber / 50m using OM4 fiber
- Two MPO-12/APC optical connectors
- 16 Watts max power
- Single 3.3V power supply
- Class 1 laser safety
- Hot pluggable, RoHS compliant
- CMIS 4.0 compliant
- Case temperature range 0°C to +70°C



Description

OSFP-800G-2xSR4 is an Eight-Channel, Parallel, Pluggable, Fiber-Optic OSFP for 800Gigabit Ethernet applications. This transceiver is a high performance module for shortrange data communication and interconnect application. It integrates eight data lanes in each direction with 8x53.125GBd. The length of OSFP SR8 is up to 30 meters over OM3 MMF or 50 meters over OM4 MMF. This module is designed to operate over multimode fiber systems using a nominal wavelength of 850nm.

The transceiver combinations guarantee optimal operation. Rigorous production testing ensures the best out-of-the-box installation experience, performance, and durability.

Absolute Maximum Specifications

Absolute maximum ratings are those beyond which damage to the device may occur.

Prolonged operation between the operational specifications and absolute maximum ratings is not intended and may cause permanent device degradation.

Table1-Absolute Maximum Specifications								
Parameter	Min.	Typical	Max.	Unit	Note			
Storage Temperature	-40		+85	°C				
Supply voltage	-0.5		3.6	V				
Relative Humidity (non- condensing)	15		85	%				
Control input voltage	-0.3		Vcc+0.5	V				
Operating Case Temperature	0		70	°C				
Receiver Damage Threshold, per Lane	5			dBm				

Recommended Operating Conditions

Table2-Recommended Operating Conditions								
Parameter	Symbol	Min	Typical	Max.	Units	Notes		
Operating Case Temperature	TOP	0		70	degC			
Relative Humidity(non-condensing)	RH	15		85	%			
Power Supply Voltage	Vcc	3.135		3.465	V			
Total Power Consumption	Pc			16	W	1		
Supply Current per end				5.1	А			
Bit Rate	BR			850	Gbps			
Fiber Length on OM3 MMF				30	m			
Fiber Length on OM4 MMF				50	m			
I ² C Clock Frequency		0		1000	kHz			

Notes:

[1] Under condition of 3.465V operating supply voltage, and $70\,^{\circ}\mathrm{C}$ case temperature.



Electrical Specifications

- 11 0 - 1 1 1 1 0 1 1 1 1 1 1 1 1 1 1 1							
Table3-Electrical Specifications Parameter	Test Point	Min.	Typical	Max.	Unit	Note	
Pre FEC Bit Error Ratio	TOST FORM		Typicat	2.4E-4	O.III.	11010	
Post FEC Bit Error Ratio	lcc			1E-12			
Transmitter (each Lane)							
Differential pk-pk Input Voltage tolerance		750			mV		
Differential Termination Mismatch				10	%		
Eye height		10			mV		
Common-mode to differential-mode		IEEEOO	2.3ck Equation	(1200 1)	dB		
return loss		IEEEOU	Z.SCK Equation	1 (1200-1)	uБ		
Vertical eye closure				12	dB		
Effective return loss		7.3			dB		
Transition Time		10			ps		
		Receiver(each	Lane)				
Differential data output swing		300		900	mVpp		
Differential termination mismatch				10	%		
Eye height		15			mV		
Vertical eye closure				12	dB		
Common-mode to differential-mode return loss		IEEE80	2.3ck Equation				
Effective return loss		8.5			dB		
Transition time		8.5			ps		

Notes:

[1] Under condition of 3.465V operating supply voltage, and $70\,^{\circ}\mathrm{C}\,$ case temperature.

Optical Specifications

Table4-Optical Specifications								
Parameter		Symbol	Min.	Typical	Max.	Unit	Note	
Transceiver								
Data rate p	er lane	DR		53.125		GBd		
Modulation	format			PAM4				
Center Wavelength		λ	840	860	868	nm	1	
RMS specti	ral width	σ	0.6			nm		
Average La	unch power, each lane	Pavg	-1		4	dBm		
Optical Power OMA, each Lane, max		D	3.5			dBm		
OMA _{outer} ,	max (TECQ, TDECQ)<1.8 dB	Рома	max [-2.6 , max(TECQ,TECQ)			dBm		



each lane				- 4.4]			
min 1.8-	<max (tecq,="" db<="" td="" tdecq)<4.4=""><td></td><td></td><td></td><td></td><td></td><td></td></max>						
Transmitter and dispersion eye closure (TDECQ), each lane		TDECQ			4.4	dB	
Transmitter eye closure for PAM4 (TECQ), each lane		TECQ			4.4	dB	
Extinction ratio		ER	2.5			dB	
Transmitter powe	er excursion, each lane				2.3	dBm	
Optical Return Lo	oss Tolerance	ORLT			14	dB	
Optical Power for	TX DISABLE				-30	dBm	
Encircled fluxb	Encircled fluxb		≥86% at 19 um ≤30% at 4.5 um				2
	Receiver						
Data rate per lan	Data rate per lane			53.125			Gbd
Modulation forma	at			PAM4			
Center Waveleng	th	λ	842	850	863	nm	
Damage threshol	ld		5			dBm	
Average receive p	oower, each lane		-6.4		4	dBm	
Receive power, each lane (OMAouter)					3.5	dBm	
Receiver reflectance		Rr			-15	dB	
Receiver sensitivity, each lane			RS = max (-4.6 , TECQ - 6.4)		2 - 6.4)	dBm	3
Stressed receiver sensitivity, each lane					-2	dBm	
	Assert		-15			dBm	
Rx LOS	De-assert				-7.5	dBm	
	Hysteresis		0.5		5	dB	

Notes:

- [1] Defined according to the performance of the laser used.
- [2] Measured into type A1a.2 or type A1a.3, or A1a.4, 50 μ s fiber, in accordance with IEC 61280-1-4.
- [3] Receiver sensitivity is informative and is defined for a transmitter with a value of TECQ. Measured with conformance test signal at TP3 for BER = 2.4E-4 Pre-FEC.



Pin Description

The device is OSFP MSA Specification for OSFP Octal Small Form Factor Pluggable Module Rev. 1.12 compliant, see www.osfpmsa.org.

ww.osfpmsa.org. Table5-Pin Description						
Pin	Symbol	Description	Pin	Symbol	Description	
1	GND	Ground	31	GND	Ground	
2	Tx2p	Transmitter Non-Inverted Data Input	32	Rx2p	Receiver Non-Inverted Data Output	
3	Tx2n	Transmitter Inverted Data Input	33	Rx2n	Receiver Inverted Data Output	
4	GND	Ground	34	GND	Grounds	
5	Тх4р	Transmitter Non-Inverted Data Input	35	Rx4p	Receiver Non-Inverted Data Output	
6	Tx4n	Transmitter Inverted Data Input	36	Rx4n	Receiver Inverted Data Output	
7	GND	Ground	37	GND	Ground	
8	Тх6р	Transmitter Non-Inverted Data Input	38	Rx6p	Receiver Non-Inverted Data Output	
9	Tx6n	Transmitter Inverted Data Input	39	Rx6n	Receiver Inverted Data Output	
10	GND	Ground	40	GND	Ground	
11	Tx8p	Transmitter Non- Inverted Data input	41	Rx8p	Receiver Non-Inverted Data Output	
12	Tx8n	Transmitter Inverted Data Input	42	Rx8n	Receiver Inverted Data Output	
13	GND	Ground	43	GND	Ground	
14	SCL	2-wire serial interface clock	44	INT / RSTn	Module Interrupt / Module Reset	
15	VCC	+3.3V Power	45	VCC	+3.3V Power	
16	VCC	+3.3V Power	46	VCC	+3.3V Power	
17	LPWn/ PRSn	Low-Power Mode / Module Present	47	SDA	2-wire Serial interface data	
18	GND	Ground	48	GND	Ground	
19	Rx7n	Receiver Inverted Data Output	49	Tx7n	Transmitter Inverted Data Input	
20	Rx7p	Receiver Non-Inverted Data Output	50	Tx7p	Transmitter Non-Inverted Data Input	
21	GND	Ground	51	GND	Ground	
22	Rx5n	Receiver Inverted Data Output	52	Tx5n	Transmitter Inverted Data Input	
23	Rx5p	Receiver Non-Inverted Data Output	53	Tx5p	Transmitter Non-Inverted Data Input	
24	GND	Ground	54	GND	Ground	
25	Rx3n	Receiver Inverted Data Output	55	Tx3n	Transmitter Inverted Data Input	
26	Rx3p	Receiver Non-Inverted Data Output	56	Тх3р	Transmitter Non-Inverted Data Input	
27	GND	Ground	57	GND	Ground	



28	Rx1n	Receiver Inverted Data Output	58	Tx1n	Transmitter Inverted Data Input
29	Rx1p	Receiver Non-Inverted Data Output	59	Tx1p	Transmitter Non-Inverted Data Input
30	GND	Ground	60	GND	Ground

OSFP Module Pad Layout

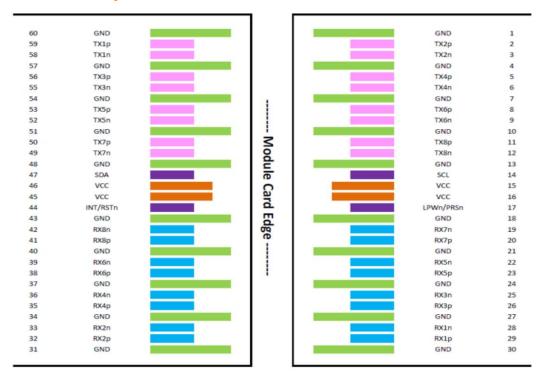


Figure 1 MSA Compliant Connector

Transceiver Block Diagram

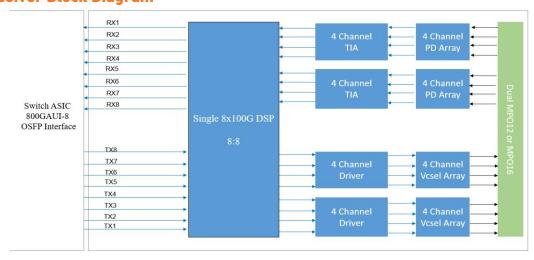
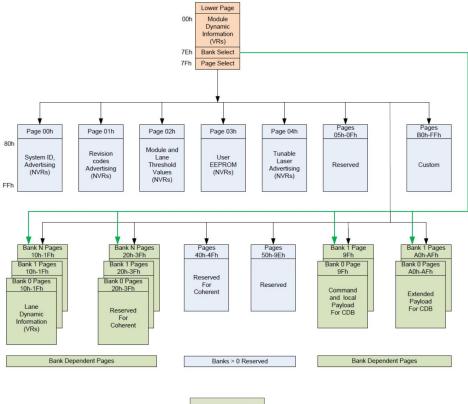


Figure 2 Transceiver Block Diagram



Management Interface



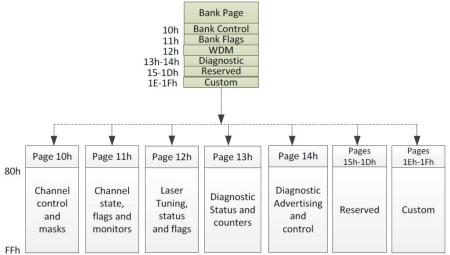


Figure 3 CMIS Module Memory Map



Optical Port Description

The optical interface port is dual MPO-12 APC receptacle. The transmit and receive optical lanes shall occupy the positions depicted in Figure 4 when looking into the MDI receptacle with the connector keyway feature on top.

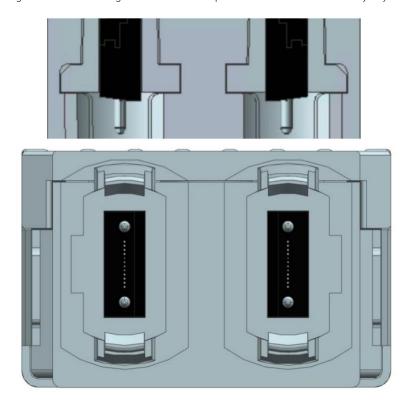


Figure 4 Optical Media Dependent Interface port assignments

Mechanical Drawing

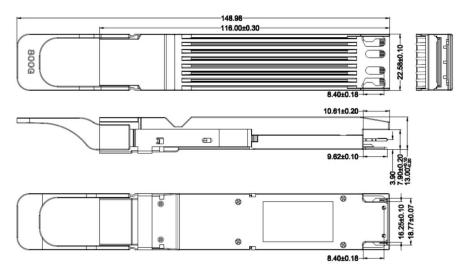


Figure 5 Mechanical Outline



Module appearance



Figure 6 Module appearance

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